ANNEX

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Status: EU Directives are being published on this site to aid cross referencing from UK legislation. After IP completion day (31 December 2020 11pm) no further amendments will be applied to this version.

ANNEX

In Annex IV to Directive 2011/65/EU, point 26 is replaced by the following:

- 26. Lead in the following applications that are used durably at a temperature below – 20 °C under normal operating and storage conditions:
- solders on printed circuit boards; (a)
- termination coatings of electrical and electronic components and coatings of printed (b) circuit boards;
- (c) solders for connecting wires and cables;
- (d) solders connecting transducers and sensors.

Lead in solders of electrical connections to temperature measurement sensors in devices which are designed to be used periodically at temperatures below – 150 °C.

These exemptions expire on 30 June 2021.